

LPGCLB55-K80C(I)

SFP 1.25Gb/s 1550nm 80km DDM1

PRODUCT FEATURES

- Up to 1.25Gbps Data Links
- 1550nm DFB laser transmitter and PIN/TIA receiver
- Maximum link length of 80km on 9/125um SMF
- Hot-pluggable SFP footprint
- Duplex LC receptacles
- Low power dissipation
- RoHS compliant and lead-free
- Support Digital Diagnostic Monitor interface
- Single +3.3V power supply
- Compliant with SFF-8472
- Case operating temperature

Commercial: 0°C to +70°C

Industrial: -40°C to +85°C



APPLICATIONS

- Gigabit Ethernet
- 1.06Gb/s Fibre Channel

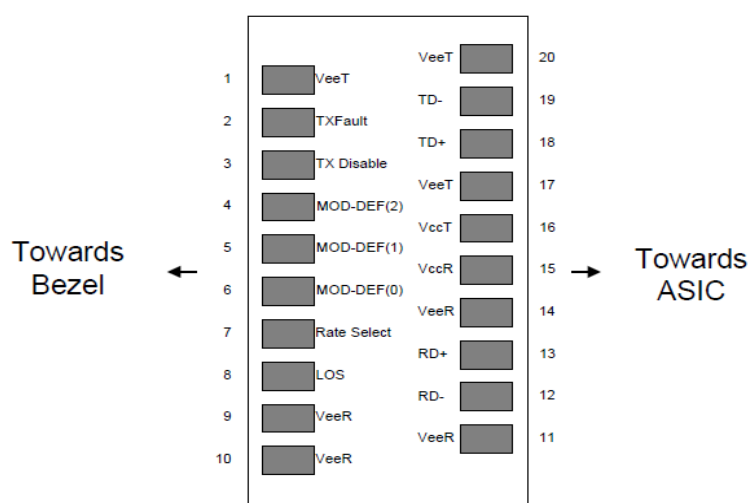
Compliance

- SFP MSA
- SFF-8472
- IEEE802.3z
- ROHS

Ordering information

Part No.	Bit Rate (Gbps)	Laser (nm)	Distance (km)	Fiber Type	DDMI	Connector	Temp
LPGCLB55-K80C	1.25	1550	80	SMF	YES	LC	0°C~70°C
LPGCLB55-K80I	1.25	1550	80	SMF	YES	LC	-40°C~85°C

I. Pin Diagram



Pinout of Connector Block on Host Board

II. Pin Descriptions

Pin	Symbol	Name/Description	Ref.
1	V_{EET}	Transmitter Ground (Common with Receiver Ground)	1
2	T_{FAULT}	Transmitter Fault.	2
3	T_{DIS}	Transmitter Disable. Laser output disabled on high or open.	3
4	MOD_DEF(2)	Module Definition 2. Data line for Serial ID.	4
5	MOD_DEF(1)	Module Definition 1. Clock line for Serial ID.	4
6	MOD_DEF(0)	Module Definition 0. Grounded within the module.	4
7	Rate Select	No connection required	
8	LOS	Loss of Signal indication. Logic "0" indicates normal operation.	5
9	V_{EER}	Receiver Ground (Common with Transmitter Ground)	

10	V _{EER}	Receiver Ground (Common with Transmitter Ground)	1
11	V _{EER}	Receiver Ground (Common with Transmitter Ground)	1
12	RD-	Receiver Inverted DATA out (CML). AC Coupled	
13	RD+	Receiver Non-inverted DATA out (CML). AC Coupled	
14	V _{EER}	Receiver Ground (Common with Transmitter Ground)	1
15	V _{CCR}	Receiver Power Supply	
16	V _{CCT}	Transmitter Power Supply	
17	V _{EET}	Transmitter Ground (Common with Receiver Ground)	1
18	TD+	Transmitter Non-Inverted DATA in. AC Coupled.	
19	TD-	Transmitter Inverted DATA in. AC Coupled.	
20	V _{EET}	Transmitter Ground (Common with Receiver Ground)	1

Notes:

1. Circuit ground is internally isolated from chassis ground.
2. T_{FAULT} is an open collector/drain output, which is pulled up with a 4.7kΩ – 10kΩ resistor on the host board, but is grounded inside the SFP cable plug.
3. Laser output disabled on T_{DIS} > 2.0V or open, enabled on T_{DIS} < 0.8V.
4. Mod-Def 0,1,2. These are the module definition pins. They should be pulled up with a 4.7K – 10KΩ resistor on the host board. The pull-up voltage shall be V_{ccT} or V_{ccR}
 Mod-Def 0 is grounded by the module to indicate that the module is present
 Mod-Def 1 is the clock line of two wire serial interface for serial ID
 Mod-Def 2 is the data line of two wire serial interface for serial ID
5. LOS is open collector output. Should be pulled up with 4.7kΩ – 10kΩ on host board to a voltage between 2.0V and 3.6V. Logic 0 indicates normal operation; logic 1 indicates loss of signal.

III. Absolute Maximum Ratings

Parameter	Symbol	Min	Type	Max	Unit	Ref.
Maximum Supply Voltage	V _{cc}	-0.5		3.6	V	
Storage Temperature	T _S	-40		85	°C	
Case Operating Temperature	T _{OP}	0		70	°C	Commercial
		-40		85		Industrial
Relative Humidity	RH	0		85	%	1

Notes:

1. Non-condensing.

IV. Optical Characteristics (TOP = 0°C to 70°C, VCC = 3.3 ± 5% Volts)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Remark
Transmitter						
Center Wavelength	λ_c	1530	1550	1570	nm	
Spectral Width(-20dB)	Pm			1	nm	
Side-mode Suppression Ratio	SMSR	30			dB	
Average Output Power	Pavg	0		5	dBm	
Extinction Ratio	ER	9			dB	
Return Loss		12			dB	
Transmitter OFF Output Power	POff			-30	dBm	
Receiver						
Center Wavelength	λ_c	1260		1600	nm	
Receiver Sensitivity, Average Power				-24	dBm	
Receiver Saturation Power	Psat			0	dBm	
Loss of Signal Assert	PA	-35			dBm	
Loss of Signal De-assert	PD			-25	dBm	
LOS Hysteresis	PD- PA	0.5			dB	

V. Electrical Characteristics (TOP = 0°C to 70°C, VCC = 3.3 ± 5% Volts)

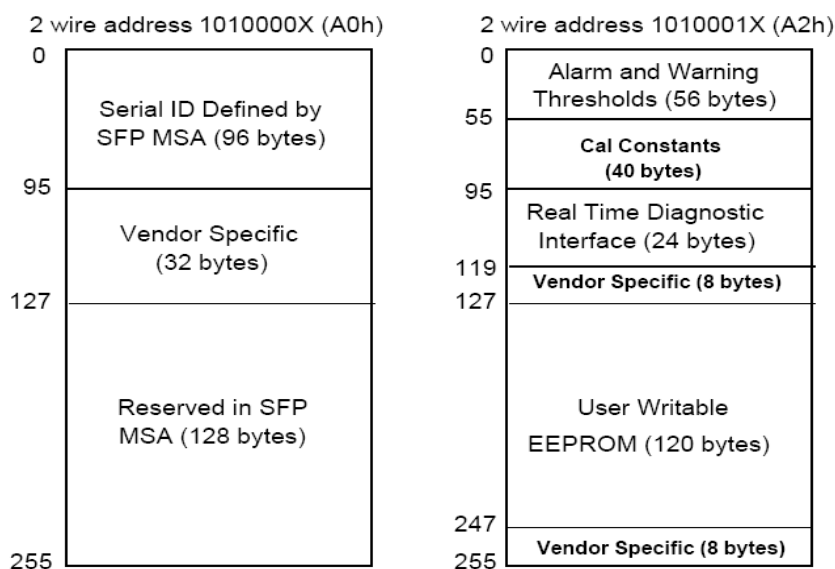
Parameter	Symbol	Min	Type	Max	Unit	Ref.
Supply Voltage	Vcc	3.135	3.3	3.465	V	
Supply Current	Icc			300	mA	
Transmitter						
Input differential impedance	Rin		100			1
Differential data input swing	Vin, pp	200		1000	mV	
Transmit Disable Voltage	VD	2		VCC	V	

Transmit Enable Voltage	V_{EN}	Vee		Vee+0.8	V	
Receiver						
Differential data output swing	$V_{out, pp}$	200		1000	mV	2
LOS Fault	V_{LOS_fault}	2		Vcc	V	3
LOS Normal	V_{LOS_norm}	Vee		Vee+0.8	V	3
Power Supply Noise Tolerance	V_{CCT}/V_{CCR}	Per SFP MSA			mVpp	

Notes:

1. Connected directly to TX data input pins.AC coupling from pins into laser driver IC.
2. Into 100Ω differential termination.
3. Loss Of Signal is LVTTTL. Logic 0 indicates normal operation; logic 1 indicates no signal detected.

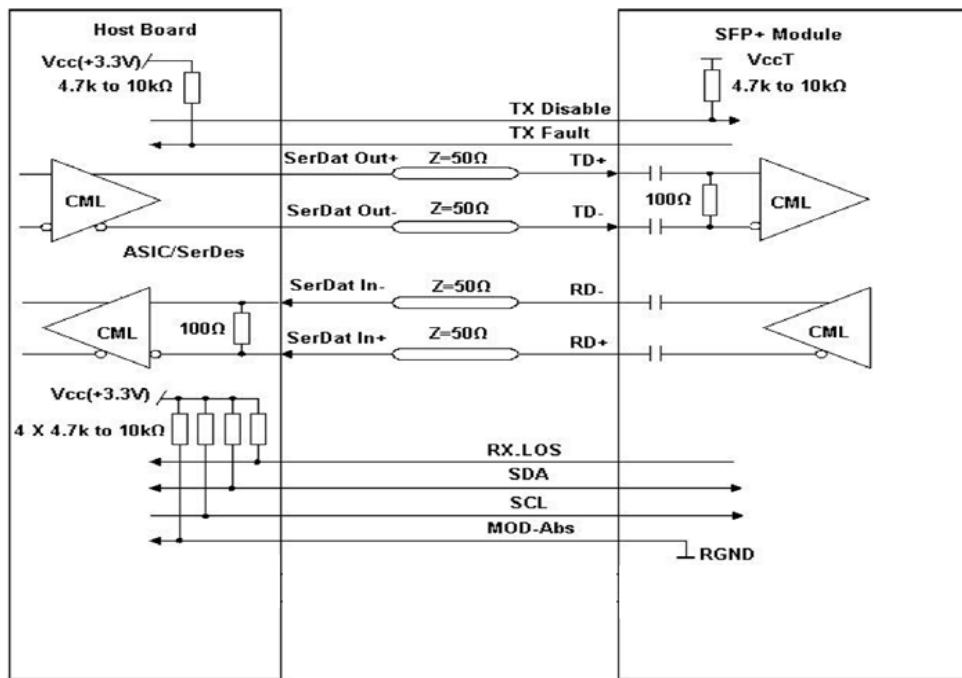
VI. Digital Diagnostic Memory Map



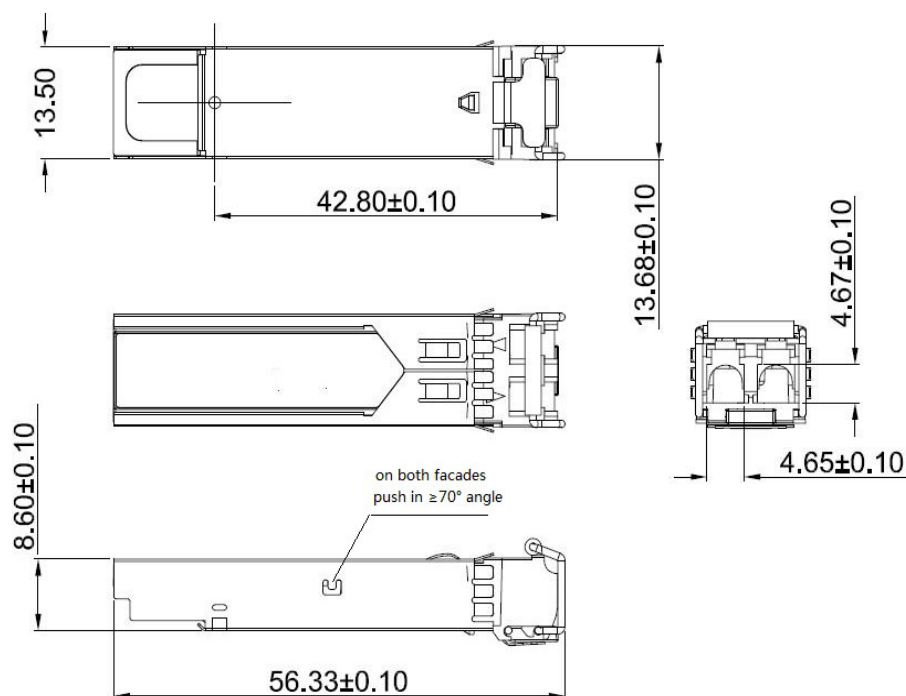
VII. Digital Diagnostic Monitoring Information

Parameter	Unit	Accuracy
Case Temperature	°C	±3
Supply Voltage	V	±3%
Tx Bias Current	mA	±10%
Tx Optical Power	dB	±3
Rx Optical Power	dB	±3

VIII.Recommended Interface Circuit



IX. Mechanical Dimensions



SFP wire mechanical drawing (Unit: mm)